

N-CHANNEL MOS FET FOR SWITCHING

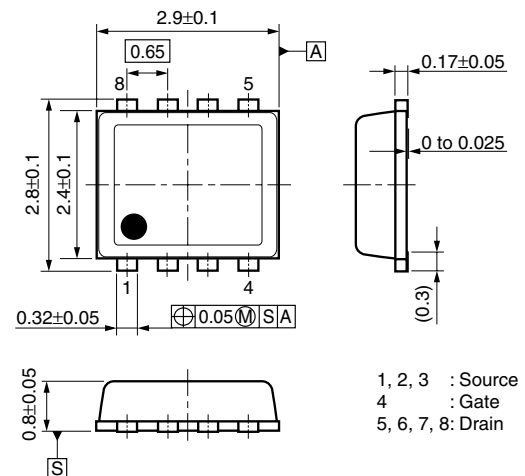
DESCRIPTION

The μ PA2521 is N-channel MOS Field Effect Transistor designed for DC/DC converter and power management applications of portable equipments.

FEATURES

- Low on-state resistance
 $R_{DS(on)1} = 16.5 \text{ m}\Omega \text{ MAX. (} V_{GS} = 10 \text{ V, } I_D = 8.0 \text{ A)}$
 $R_{DS(on)2} = 25 \text{ m}\Omega \text{ MAX. (} V_{GS} = 4.5 \text{ V, } I_D = 4.0 \text{ A)}$
- Built-in gate protection diode
- Small and surface mount package (8-pin VSOFF (2429))
- Pb-free (This product does not contain Pb in external electrode and other parts.)

PACKAGE DRAWING (Unit: mm)



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$, All terminals are connected.)

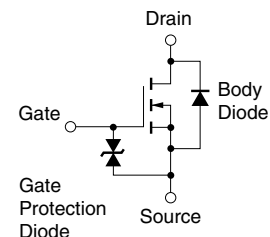
Drain to Source Voltage ($V_{GS} = 0 \text{ V}$)	V_{DSS}	30	V
Gate to Source Voltage ($V_{DS} = 0 \text{ V}$)	V_{GSS}	± 20	V
Drain Current (DC)	$I_{D(DC)}$	± 8	A
Drain Current (pulse) ^{Note1}	$I_{D(pulse)}$	± 32	A
Total Power Dissipation ^{Note2}	P_{T1}	1.0	W
Total Power Dissipation (PW = 5 sec) ^{Note2}	P_{T2}	2.2	W
Channel Temperature	T_{ch}	150	$^\circ\text{C}$
Storage Temperature	T_{stg}	$-55 \text{ to } +150$	$^\circ\text{C}$
Single Avalanche Current ^{Note3}	I_{AS}	8	A
Single Avalanche Energy ^{Note3}	E_{AS}	6.4	mJ

Notes 1. $PW \leq 10 \mu\text{s}$, Duty Cycle $\leq 1\%$

2. Mounted on FR-4 board of 25.4 mm x 25.4 mm x 0.8 mm

3. Starting $T_{ch} = 25^\circ\text{C}$, $V_{DD} = 15 \text{ V}$, $R_G = 25 \Omega$, $V_{GS} = 20 \rightarrow 0 \text{ V}$, $L = 100 \mu\text{H}$

EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

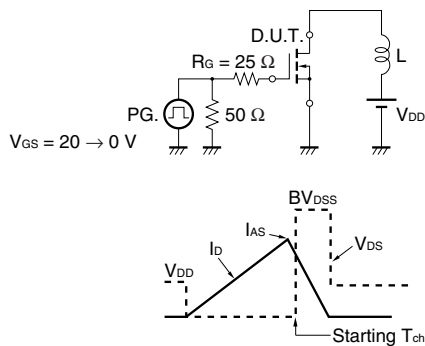
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ELECTRICAL CHARACTERISTICS (TA = 25°C, All terminals are connected.)

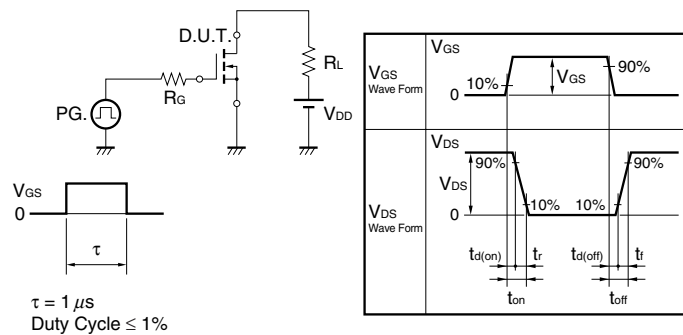
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 30\text{ V}, V_{GS} = 0\text{ V}$			10	μA
Gate Leakage Current	I_{GSS}	$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$			±10	μA
Gate to Source Cut-off Voltage	$V_{GS(off)}$	$V_{DS} = 10\text{ V}, I_D = 1\text{ mA}$	1.5		2.5	V
Forward Transfer Admittance ^{Note}	$ y_{fs} $	$V_{DS} = 10\text{ V}, I_D = 4.0\text{ A}$	3.2			S
Drain to Source On-state Resistance ^{Note}	$R_{DS(on)1}$	$V_{GS} = 10\text{ V}, I_D = 8.0\text{ A}$		12	16.5	mΩ
	$R_{DS(on)2}$	$V_{GS} = 4.5\text{ V}, I_D = 4.0\text{ A}$		17	25	mΩ
Input Capacitance	C_{iss}	$V_{DS} = 15\text{ V},$		780		pF
Output Capacitance	C_{oss}	$V_{GS} = 0\text{ V},$		170		pF
Reverse Transfer Capacitance	C_{rss}	$f = 1\text{ MHz}$		61		pF
Turn-on Delay Time	$t_{d(on)}$	$V_{DD} = 15\text{ V}, I_D = 4.0\text{ A},$		9.2		ns
Rise Time	t_r	$V_{GS} = 10\text{ V},$		3.8		ns
Turn-off Delay Time	$t_{d(off)}$	$R_G = 10\ \Omega$		31		ns
Fall Time	t_f			4.8		ns
Total Gate Charge	Q_G	$V_{DD} = 15\text{ V},$		7.6		nC
Gate to Source Charge	Q_{GS}	$V_{GS} = 5\text{ V},$		2.6		nC
Gate to Drain Charge	Q_{GD}	$I_D = 8\text{ A}$		2.4		nC
Body Diode Forward Voltage ^{Note}	$V_{F(S-D)}$	$I_F = 8\text{ A}, V_{GS} = 0\text{ V}$		0.82		V
Reverse Recovery Time	t_{rr}	$I_F = 8\text{ A}, V_{GS} = 0\text{ V},$		24		ns
Reverse Recovery Charge	Q_{rr}	$di/dt = 100\text{ A}/\mu\text{s}$		17		nC
Gate Resistance	R_G	$f = 1\text{ MHz}$		1.6		Ω

Note Pulsed

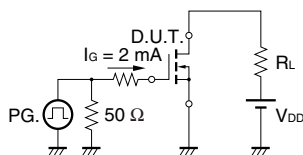
TEST CIRCUIT 1 AVALANCHE CAPABILITY



TEST CIRCUIT 2 SWITCHING TIME

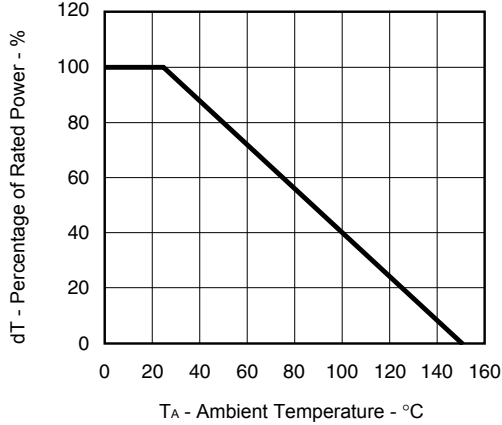


TEST CIRCUIT 3 GATE CHARGE

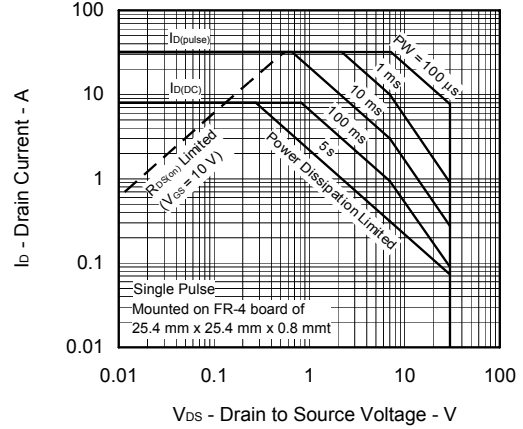


TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$)

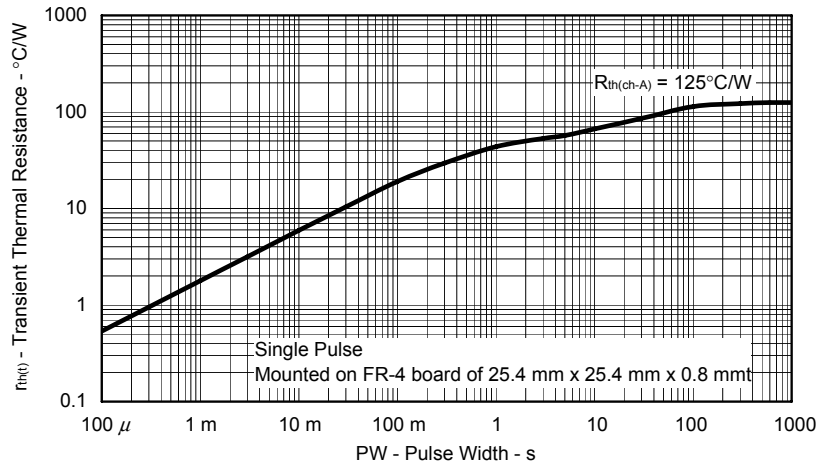
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



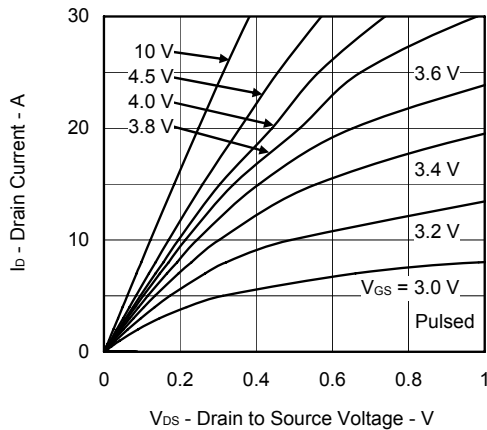
FORWARD BIAS SAFE OPERATING AREA



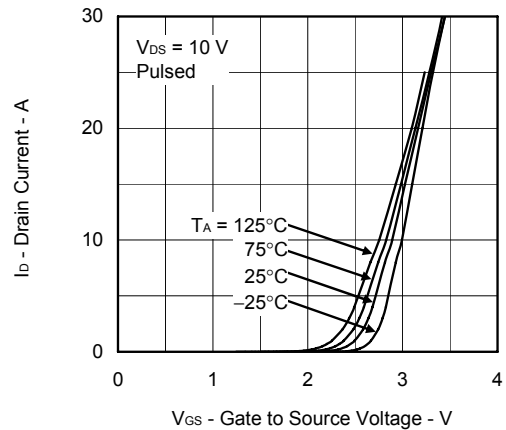
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



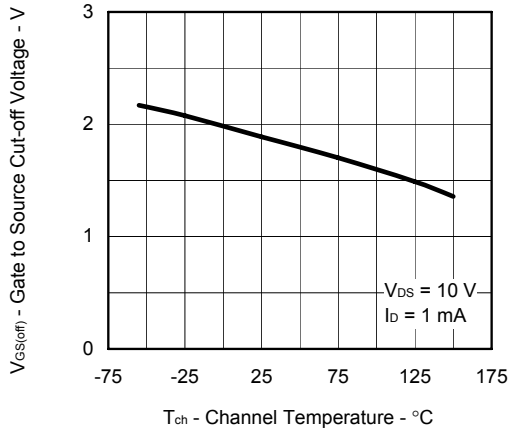
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



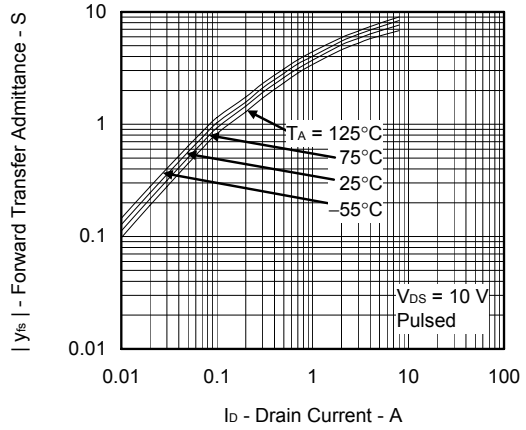
FORWARD TRANSFER CHARACTERISTICS



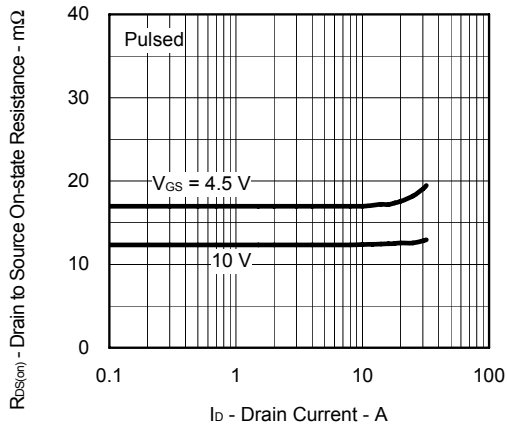
GATE TO SOURCE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE



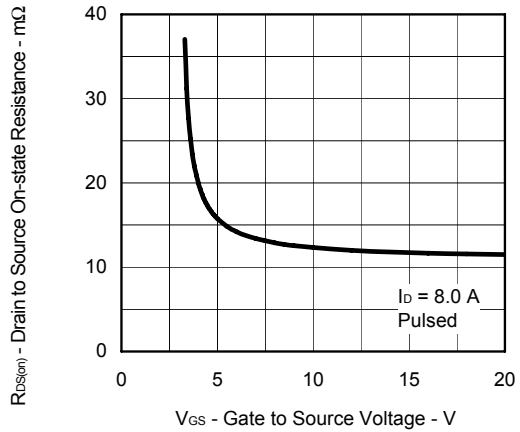
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



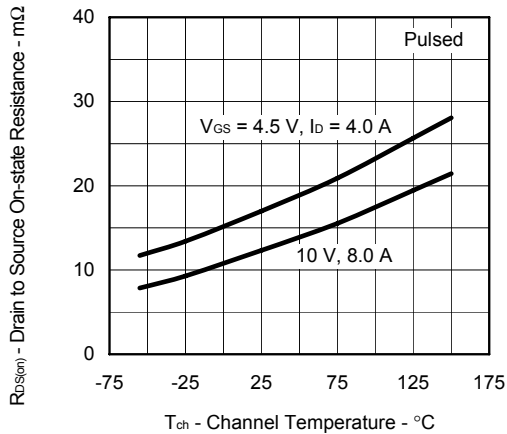
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



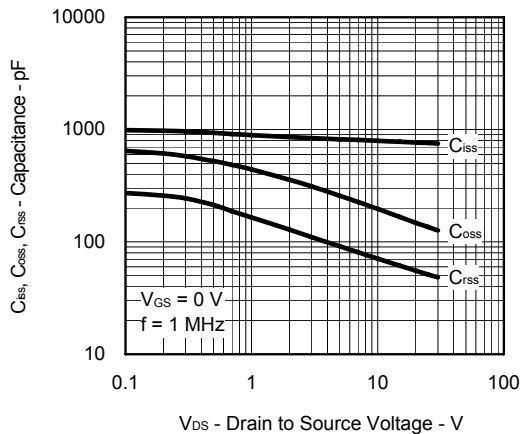
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

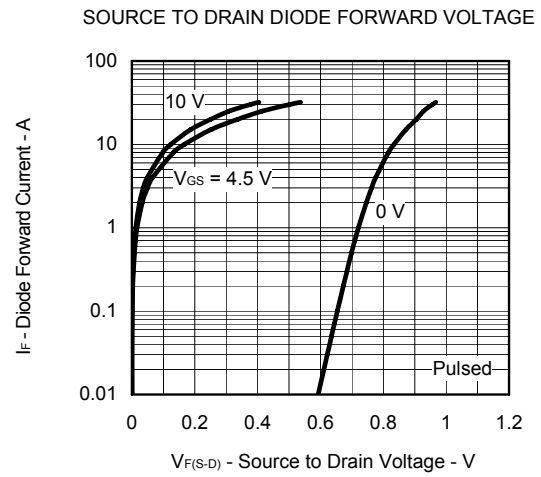
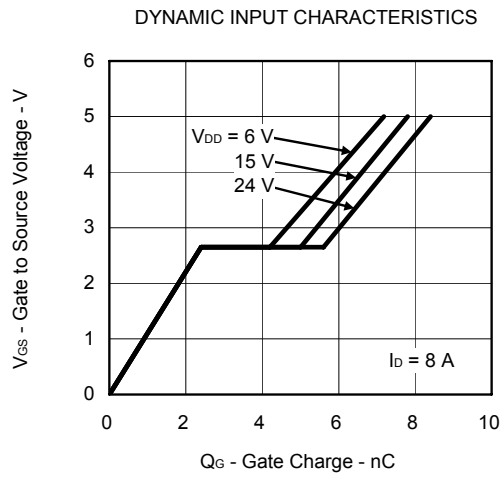


DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE





ORDERING INFORMATION

PART NUMBER	LEAD PLATING	PACKING	PACKAGE
μ PA2521T1H-T1-AT ^{Note}	Pure Sn	8 mm embossed taping	8-pin VSOF (2429)
μ PA2521T1H-T2-AT ^{Note}		3000 p/reel	

Note Pb-free (This product does not contain Pb in external electrode and other parts.)

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